



Features

- Ultra High Stability MCXO
- Low Power Consumption
- Up to 105°C in preparation
- Meets Stratum 3 acc. GR-1244
- ROHS 6 Compliant
- Frequency Range¹: 8 50 MHz
- Standard Frequencies: 10, 12.8, 16.384, 19.2, 20, 22.1184, 24.576, 25, 38.4, 40 MHz
- Uses Vectron's Ultra Smooth Compensation (USC) Algorithm
- Excellent Phase Noise and Allan Deviation

Applications

- 1588 Application
- Test Equipment
- Femto Base Station
- Communication Equipment

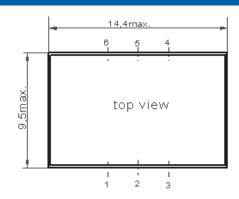
Performance Specifications

Frequency Stabilities ^{1, 3} (Standard - 8 to 26 MHz)							
Parameter	Min	Typical	Max	Units	Condition ²		
vs. operating temperature range referenced to (dFmax+dFmin)/2	-20 -30 -100		+20 +30 +100	ppb ppb ppb	-20 to +70°C -40 to +85°C -40 to +105°C	Options ³	
In a 24h period at constant temperature	-5		+5	ppb	after 7 days of continous operation		
Frequency vs. temperature slope		±1.0 ±1.5		ppb/°C ppb/°C	-30 to +80°C, 10 & 20MHz -40 to +85°C, 10 & 20MHz		
Initial tolerance vs. supply voltage change vs. load change vs. aging / 1. year vs. aging / 10 years	-0.5 -10 -10 -0.8 -2.5		+0.5 +10 +10 +0.8 +2.5	ppm ppb ppb ppm ppm	V _s ±5% static Load ±10% static after 30 days of operation after 30 days of operation		

Performance Specifications

Supply Voltage (V¸)						
Parameter	Min	Typical	Max	Units	Condition ²	
Supply Voltage (standard)	3.135	3.3	3.465	V		
Current Consumption			12	mA	8 - 50MHz	
Supply Voltage (Option)	4,75	5	5.25	V		
Current Consumption			8	mA		
			RF Outpu	t		
Signal [standard]		HCN	ИOS			
Load		15		pF		
Signal Level (Vol)			0.3	V	Vs = 3.3V	
Signal Level (Voh)	3			V	Vs = 3.3V	
Duty Cycle	45		55	%	@ V _. /2	
Rise and Fall time			5	ns	10 to 90 %	
		Frequency 1	Tuning (EFC	2) 8 to 26 MHz		
Tuning Range	F	ixed frequer	ncy; No adju	st		on³
Tuning Range	±3.5		+10	ppm		Option ³
Linearity			2	%	10 & 20MHz	
Tuning Slope		 Posi	itive	<u> </u>		
Control Input Impedance	20			kOhm		
Control Voltage (V _.) Range	0.0	1.65	3.3	V	@ 3.3V	
	0.5	2.5	4.5	V	@ 5V	
			tional Para	meters		
		-65		dBc/Hz	1 Hz	
		-93		dBc/Hz	10 Hz	
Phase Noise ⁴		-118		dBc/Hz		@ 20MHz
Thase Noise		-140		dBc/Hz	1 kHz	
		-154 -156		dBc/Hz dBc/Hz	10 kHz 100 kHz	
ADEV			80	E-12	@ 1sec.	
			80	E-12	@10sec	
Weight			2.0	g		
Processing & Packing	H	landling & Pr	ocessing No	te		
Reflow Profile	IPC / J	IEDEC J-STD-	020 (latest v	ersion)		
		Absolut	te Maximur	n Ratings		
Supply Voltage (V _ε)	-0.6		6.0	V		
Output Load			50	pF		
Operable Temperature Range	-40		+85	°C		
Storage Temperature Range	-40		+90	°C		
		Enviro	nmental Co	nditi <u>ons</u>		
Rapid Temperature Changes MIL-883-1010 Cond B 500 cycles -55/125C						
Vibration	MIL-STD-883 Meth 2007 Cond A 20G 20-2000Hz 4x in each 3axis 4 min					
Shock	MIL-STD-202 Meth 213B Cond. F; 1500g 0,5ms 6 shocks in each direction					
Solderability	J_STD_002C Cond A, Through hole device/ Cond. B, SMD 255C (diving time 50,5sec.) Dip+Look with 8h damp pre-treatment: solder wetting >95%					
Solvent Resistance	MIL-STD-883 Meth 2015 Solv. 1,3,4					
ESD	JESD22-A114F Class 1B; 10* 2000V					
Moisture Sensitivity	Level 1 JESD22-A113-B					
Moisture Sensitivity				LCVCI I JLJDZ2	2 / (113)	

Outline Drawing / Enclosure



G 287

MX-503					
Height "H"	Pin Length "L"				
3.8	NA				

Pin Connections

1

2 3

4

5

6

Control Voltage Input (Vc) / N.C.

Enable / N.C.

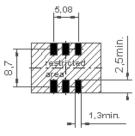
Ground (Case)

RF-Output

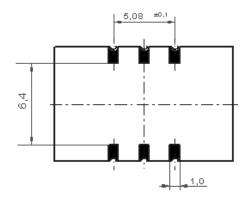
N.C.

Supply Voltage Input (Vs)

£0,3	
エ	
-	<u> </u>



Enable true table (optional): MX-503				
Pin 2	Pin 4			
High	Data			
Open	Data			
Low	High Tristate			

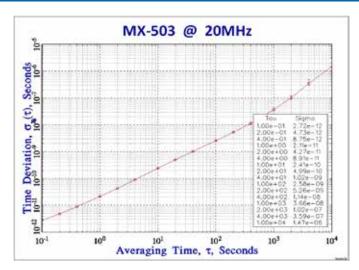


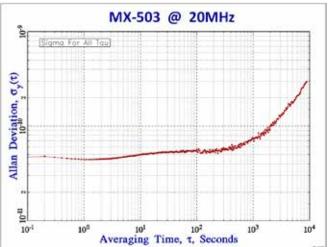
Dimensions in mm

5,08
2 2 min
1,3min.

Performance Data

TDEV-without filter





ADEV

Temperature Stability

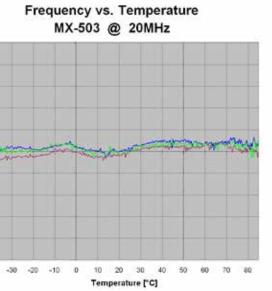
MX-503 @ 20MHz 50 40 30 Delta Frequency [ppb]

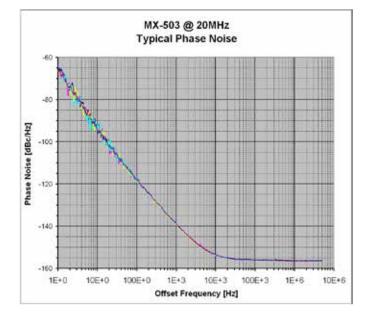
10

-10 -20

-30 -40

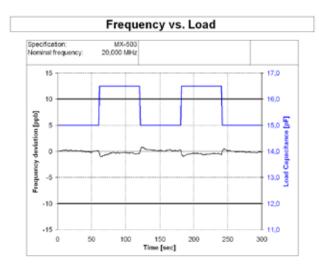
Phase Noise4

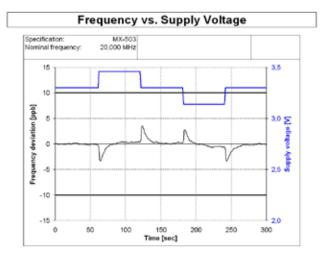




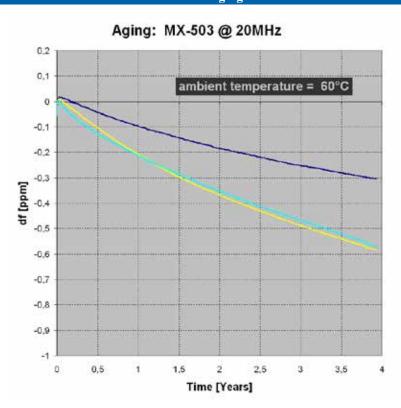
Frequency vs. Load

Frequency vs. Supply Voltage





Aging



Recommended Reflow Profile

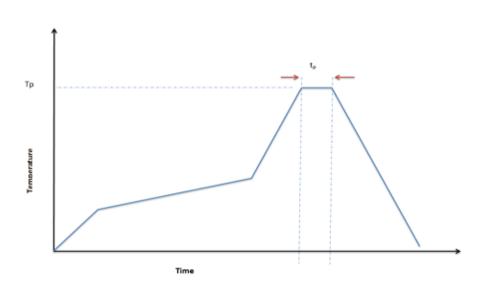
TP: max 250°C (@ solder joint, customer board level)

T_p: max: 10...30 sec

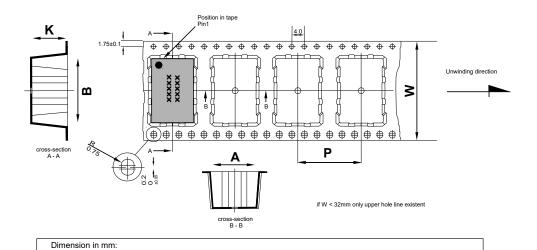
Additional Information:

This SMD oscillator has been designed for pick and place reflow soldering

SMD oscillators must be on the top side of the PCB during the reflow process.



Standard Shipping Method (MX-503)

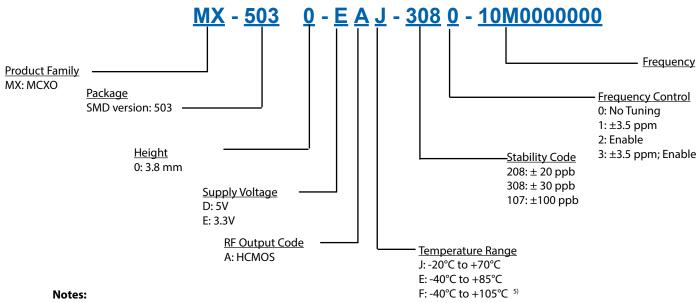


All dimensions in millimeters unless otherwise stated

Enclosure Type	Tape Width W (mm)	Quantity per meter	Quantity per reel	Dimension P
G287	24	83,3	750	16

A, B and K are dependent uppon component dimensions production tolerance complying DIN IEC 286-3

Ordering Information^{1,3}



- 1. Contact factory for other frequencies. Not all options and codes are available at all frequencies.
- 2. Unless otherwise stated conditions are valid at F=20MHz; V_e=3.3V; V_e=1.65; T=25°C; Output Signal=HCMOS; load=15pF
- 3. Contact factory for availability.
- 4. Phase noise degrades with increasing output frequency.
- 5. In preparation with stability code 107

Subject to technical modification.

Contact Information

USA:

100 Watts Street Mt Holly Springs, PA 17065 Tel: 1.717.486.3411

Fax: 1.717.486.5920

Europe:

Landstrasse 74924 Neckarbischofsheim Germany Tel: +49 (0) 7268.801.0

Fax: +49 (0) 7268.801.281



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